

N-Channel Reduced Q_g , Fast Switching MOSFET

| PRODUCT SUMMARY | | |
|-----------------|----------------------------|-----------|
| V_{DS} (V) | $R_{DS(on)}$ (Ω) | I_D (A) |
| 30 | 0.0032 at $V_{GS} = 10$ V | 25 |
| | 0.0036 at $V_{GS} = 4.5$ V | 22 |

FEATURES

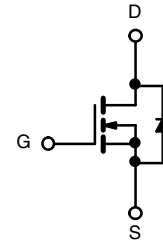
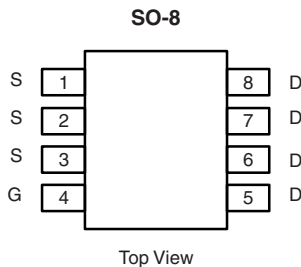
- Halogen-free According to IEC 61249-2-21 Definition
- Extremely Low Q_{gd} for Switching Losses Improvement
- TrenchFET[®] Gen II Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC



RoHS
COMPLIANT
HALOGEN
FREE
Available

APPLICATIONS

- Low-Side DC/DC Conversion
- Notebook, Server, VRM Module
- Fixed Telecom



N-Channel MOSFET

Ordering Information: Si4368DY-T1-E3 (Lead (Pb)-free)
Si4368DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

| ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C, unless otherwise noted) | | | | | |
|---|----------------|---------------|---------------|------|-----|
| Parameter | Symbol | 10 s | Steady State | Unit | |
| Drain-Source Voltage | V_{DS} | 30 | | V | |
| Gate-Source Voltage | V_{GS} | ± 12 | | | |
| Continuous Drain Current ($T_J = 150$ °C) ^a | I_D | $T_A = 25$ °C | 25 | 17 | A |
| | | $T_A = 70$ °C | 20 | 13 | |
| Pulsed Drain Current (10 μ s Pulse Width) | I_{DM} | 70 | | | |
| Continuous Source Current (Diode Conduction) ^a | I_S | 2.9 | 1.3 | | |
| Avalanch Current | I_{AS} | L = 0.1 mH | 50 | | |
| Maximum Power Dissipation ^a | | | $T_A = 25$ °C | 3.5 | 1.6 |
| | $T_A = 70$ °C | 2.2 | 1 | | |
| Operating Junction and Storage Temperature Range | T_J, T_{stg} | - 55 to 150 | | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|--|------------|---------------|---------|------|------|
| Parameter | Symbol | Typical | Maximum | Unit | |
| Maximum Junction-to-Ambient ^a | R_{thJA} | $t \leq 10$ s | 29 | 35 | °C/W |
| | | Steady State | 67 | 80 | |
| Maximum Junction-to-Foot (Drain) | R_{thJF} | 13 | 16 | | |

Notes:

a. Surface mounted on 1" x 1" FR4 board.



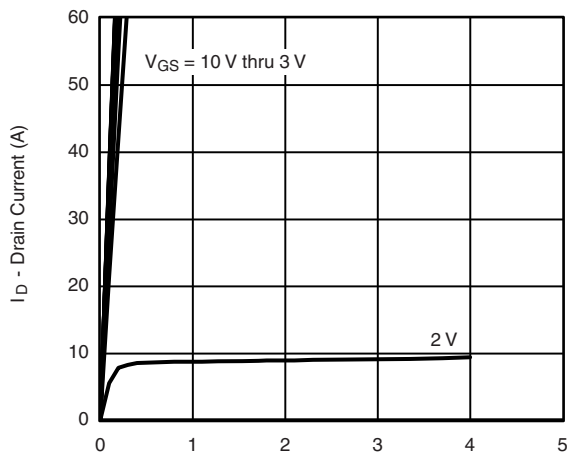
| SPECIFICATIONS (T _J = 25 °C, unless otherwise noted) | | | | | | |
|---|---------------------|--|--|--------|--------|------|
| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
| Static | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = 250 μA | 0.6 | | 1.8 | V |
| Gate-Body Leakage | I _{GSS} | V _{DS} = 0 V, V _{GS} = ± 12 V | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 30 V, V _{GS} = 0 V | | | 1 | μA |
| | | V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C | | | 5 | |
| On-State Drain Current ^a | I _{D(on)} | V _{DS} ≥ 5 V, V _{GS} = 10 V | 30 | | | A |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 10 V, I _D = 25 A | | 0.0026 | 0.0032 | Ω |
| | | V _{GS} = 4.5 V, I _D = 22 A | | 0.0029 | 0.0036 | |
| Forward Transconductance ^a | g _{fs} | V _{DS} = 15 V, I _D = 25 A | | 150 | | S |
| Diode Forward Voltage ^a | V _{SD} | I _S = 2.9 A, V _{GS} = 0 V | | 0.66 | 1.1 | V |
| Dynamic^b | | | | | | |
| Input Capacitance | C _{iss} | V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz | | 8340 | | pF |
| Output Capacitance | C _{oss} | | | 850 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 355 | | |
| Total Gate Charge | Q _g | V _{DS} = 15 V, V _{GS} = 4.5 V, I _D = 20 A | | 53 | 80 | nC |
| Gate-Source Charge | Q _{gs} | | | 17.5 | | |
| Gate-Drain Charge | Q _{gd} | | | 6.5 | | |
| Gate Resistance | R _g | f = 1 MHz | 0.8 | 1.2 | 1.8 | Ω |
| Turn-On Delay Time | t _{d(on)} | V _{DD} = 15 V, R _L = 15 Ω I _D ≅ 1 A, V _{GEN} = 10 V, R _g = 6 Ω | | 25 | 38 | ns |
| Rise Time | t _r | | | 20 | 30 | |
| Turn-Off Delay Time | t _{d(off)} | | | 172 | 260 | |
| Fall Time | t _f | | | 41 | 62 | |
| Source-Drain Reverse Recovery Time | t _{rr} | | I _F = 2.9 A, dI/dt = 100 A/μs | | 42 | |

Notes:

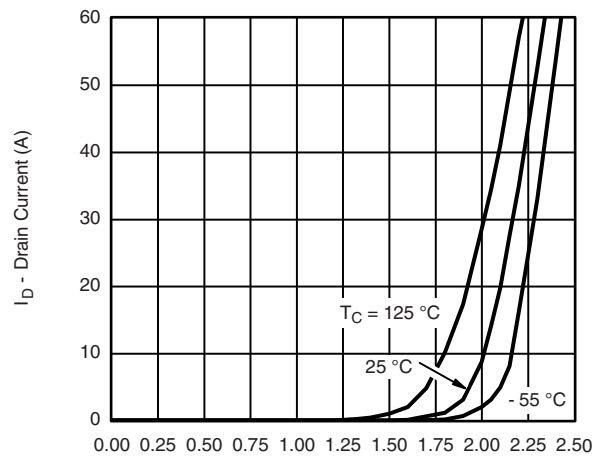
- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

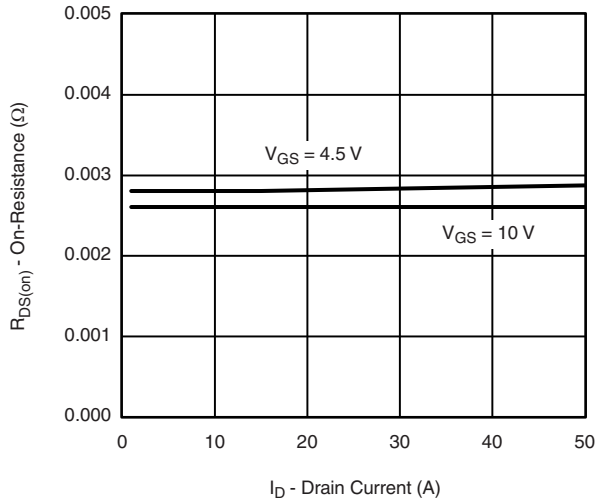


Output Characteristics

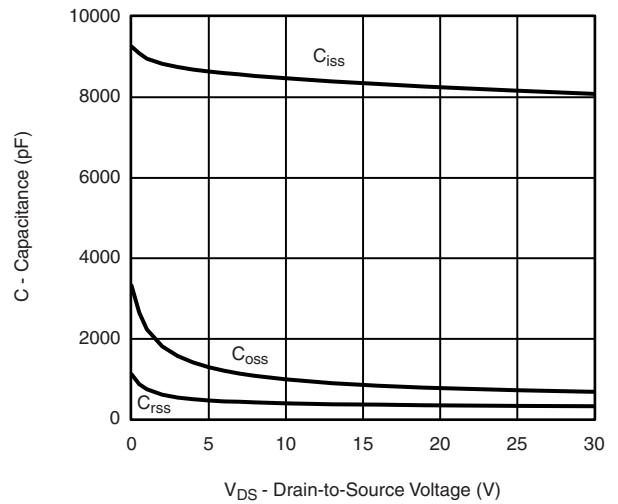


Transfer Characteristics

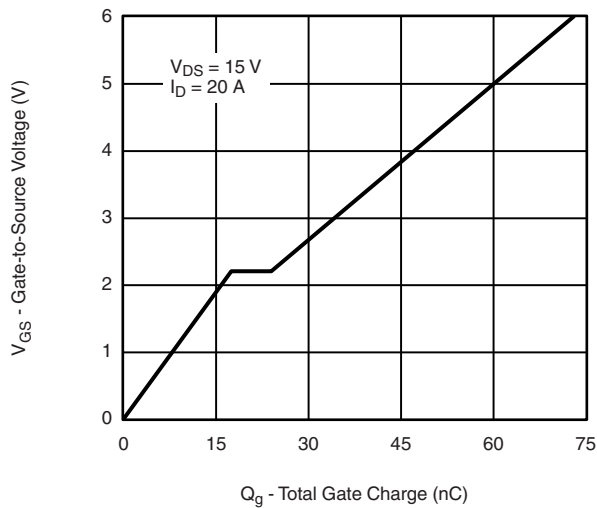
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



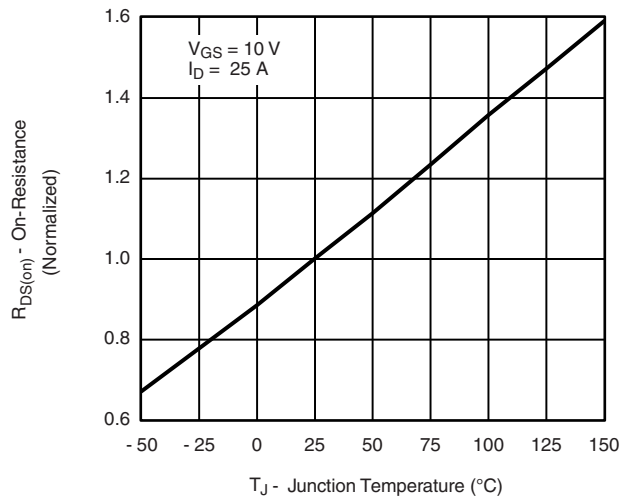
On-Resistance vs. Drain Current



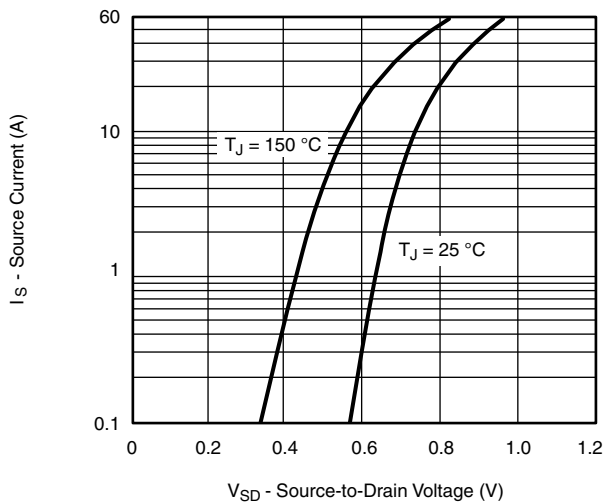
Capacitance



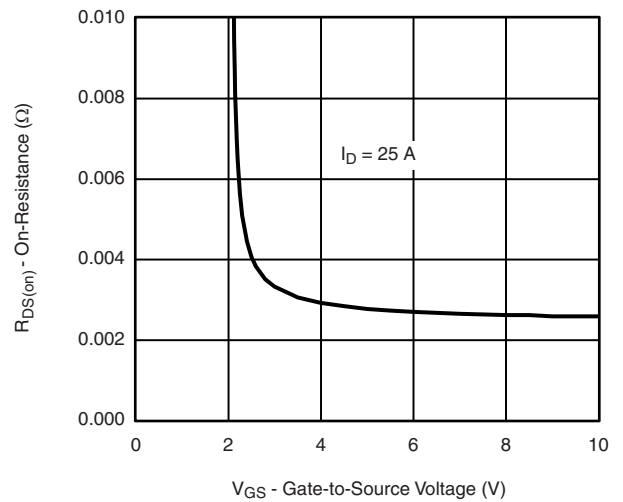
Gate Charge



On-Resistance vs. Junction Temperature

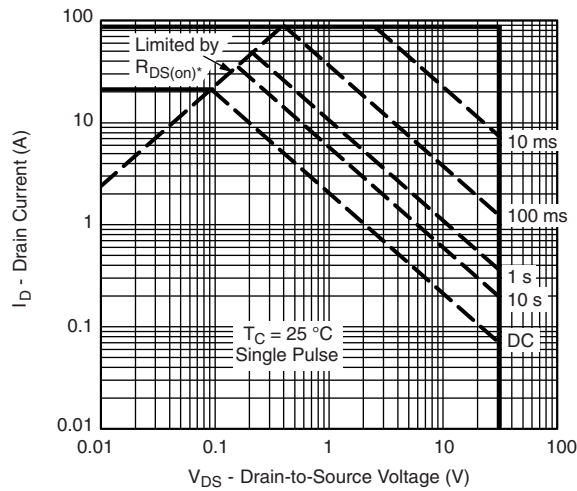
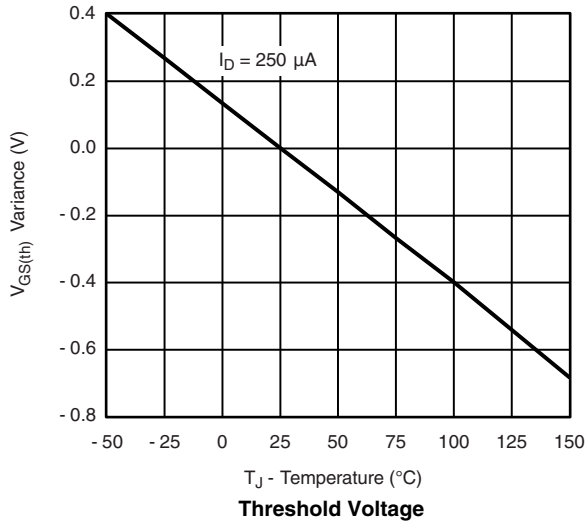


Source-Drain Diode Forward Voltage

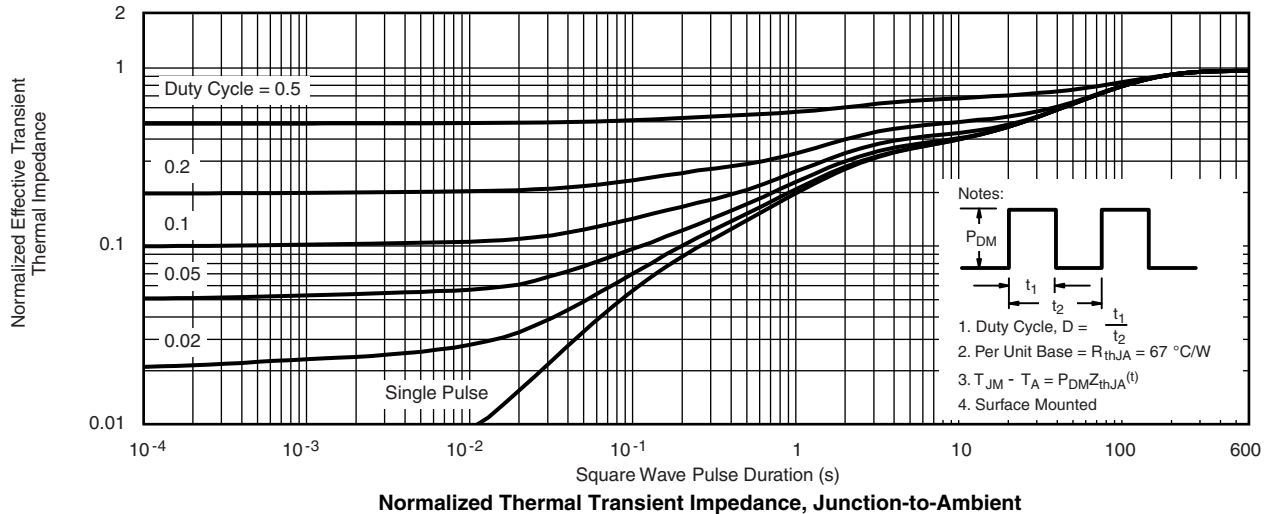


On-Resistance vs. Gate-to-Source Voltage

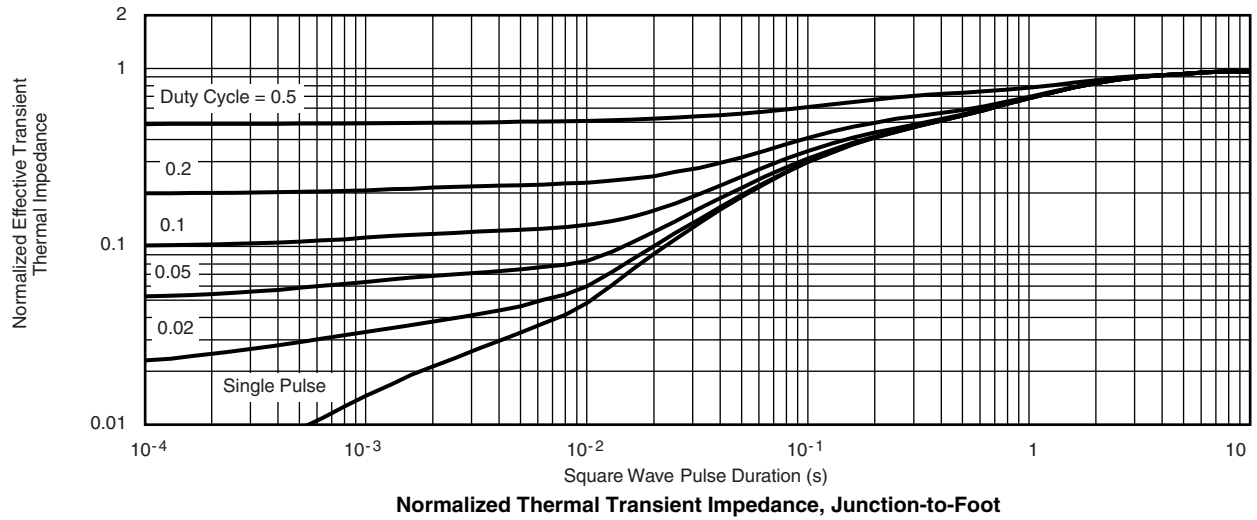
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



* $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012



| DIM | MILLIMETERS | | INCHES | |
|--------------------------------|-------------|------|-----------|-------|
| | Min | Max | Min | Max |
| A | 1.35 | 1.75 | 0.053 | 0.069 |
| A ₁ | 0.10 | 0.20 | 0.004 | 0.008 |
| B | 0.35 | 0.51 | 0.014 | 0.020 |
| C | 0.19 | 0.25 | 0.0075 | 0.010 |
| D | 4.80 | 5.00 | 0.189 | 0.196 |
| E | 3.80 | 4.00 | 0.150 | 0.157 |
| e | 1.27 BSC | | 0.050 BSC | |
| H | 5.80 | 6.20 | 0.228 | 0.244 |
| h | 0.25 | 0.50 | 0.010 | 0.020 |
| L | 0.50 | 0.93 | 0.020 | 0.037 |
| q | 0° | 8° | 0° | 8° |
| S | 0.44 | 0.64 | 0.018 | 0.026 |
| ECN: C-06527-Rev. I, 11-Sep-06 | | | | |
| DWG: 5498 | | | | |

RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads
Dimensions in Inches/(mm)

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